

### Electrical Features

- Low Switching Losses
- Trench/Fieldstop IGBT
- $V_{CEsat}$  with positive Temperature Coefficient
- Low  $V_{CEsat}$

### Typical Applications

- Auxiliary Inverters
- Air Conditioning
- Motor Drives



### Mechanical Features

- $Al_2O_3$  Substrate with Low Thermal Resistance
- Compact design
- Solder Contact Technology
- Rugged mounting due to integrated mounting clamps

### IGBT, Inverter

Maximum Rated Values							
Symbol	Item	Conditions	Rating			Unit	
IGBT							
$V_{CES}$	Collector-emitter voltage	$T_{vj}=25^{\circ}C$	1200			V	
$V_{GES}$	Gate-emitter voltage	-	$\pm 20$			V	
$I_C$	Collector current,DC	$T_C=100^{\circ}C, T_{vj}=175^{\circ}C$	15			A	
$I_{CRM}$	Repetitive peak collector current	$t_p=1ms$	30			A	
$P_{tot}$	Total power dissipation	$T_C=25^{\circ}C, T_{vj}=175^{\circ}C$	130			W	
Characteristics Values							
Symbol	Item	Conditions	Values			Unit	
			Min.	Typ.	Max.		
$I_{CES}$	Collector-emitter cut-off current	$V_{CE}=1200V, V_{GE}=0V, T_{vj}=25^{\circ}C$	-	-	1	mA	
$I_{GES}$	Gate leakage current	$V_{CE}=0V, V_{GE}=20V, T_{vj}=25^{\circ}C$	-	-	500	nA	
$V_{GE(th)}$	Gate-emitter threshold voltage	$I_C=0.5mA, V_{CE}=V_{GE}, T_{vj}=25^{\circ}C$	5.2	5.7	6.5	V	
$V_{CEsat}$	Collector-emitter saturation voltage	$I_C=15A$ $V_{GE}=15V$	$T_{vj}=25^{\circ}C$	-	2.0		-
			$T_{vj}=125^{\circ}C$	-	-		-
			$T_{vj}=150^{\circ}C$	-	-	-	
$C_{ies}$	Input capacitance	$V_{CE}=25V, V_{GE}=0V$ $f=1MHz, T_{vj}=25^{\circ}C$	-	1.19	-	nF	
$C_{oes}$	Output capacitance		-	0.08	-		
$C_{res}$	Reverse transfer capacitance		-	0.04	-		
$Q_G$	Gate charge	$V_{CC}=600V, I_C=15A$ $V_{GE}=-15...+15V, T_{vj}=25^{\circ}C$	-	94	-	nC	
$R_g$	Internal gate resistance	$T_{vj}=25^{\circ}C$	-	-	-	$\Omega$	

$t_{d(on)}$	Turn-on delay time	$V_{CC}=600V$ $I_C=15A$ $V_{GE}=\pm 15V$ $R_{G(on)}=10\Omega$ $R_{G(off)}=10\Omega$	$T_{vj}=25^\circ C$	-	8.73	-	ns
			$T_{vj}=125^\circ C$	-	7.85	-	
			$T_{vj}=150^\circ C$	-	-	-	
$t_r$	Rise time		$T_{vj}=25^\circ C$	-	45.4	-	
			$T_{vj}=125^\circ C$	-	8.14	-	
			$T_{vj}=150^\circ C$	-	-	-	
$t_{d(off)}$	Turn-off delay time		$T_{vj}=25^\circ C$	-	112.2	-	
			$T_{vj}=125^\circ C$	-	125.1	-	
			$T_{vj}=150^\circ C$	-	-	-	
$t_f$	Fall time		$T_{vj}=25^\circ C$	-	325.5	-	
			$T_{vj}=125^\circ C$	-	387.8	-	
			$T_{vj}=150^\circ C$	-	-	-	
$E_{on}$	Turn-on energy (per pulse)	$T_{vj}=25^\circ C$	-	1.62	-	mJ	
		$T_{vj}=125^\circ C$	-	2.04	-		
		$T_{vj}=150^\circ C$	-	-	-		
$E_{off}$	Turn-off energy (per pulse)	$T_{vj}=25^\circ C$	-	0.68	-		
		$T_{vj}=125^\circ C$	-	1.0	-		
		$T_{vj}=150^\circ C$	-	-	-		
SC data	Short-circuit current	$V_{CC}=600V, V_{GE}\leq 15V, T_{vj}=125^\circ C$ $V_{CES}\leq 1200V, t_p\leq 10\mu s$	-	99	-	A	
$R_{thJC}$	Thermal resistance, junction to case	Per IGBT	-	1.05	1.15	K/W	
$R_{thCH}$	Thermal resistance, case to heatsink	Per IGBT $\lambda_{grease}=1W/(m\cdot K)$	-	1.05	-	K/W	
$T_{vjop}$	Temperature under switching conditions		-40		150	$^\circ C$	

**Diode, Inverter**

**Maximum Rated Values**

Symbol	Item	Conditions	Rating	Unit
$V_{RRM}$	Repetitive peak reverse voltage	$T_{vj}=25^\circ C$	1200	V
$I_F$	Forward current, DC		15	A
$I_{FRM}$	Repetitive peak forward current	$t_p=1ms$	30	A
$I^2t$	$I^2t$ -value	$V_R=0V, t_p=10ms, T_{vj}=150^\circ C$	14	$A^2s$

**Characteristic Values**

$V_F$	Continuous forward voltage	$I_F=15A$ $V_{GE}=0V$	$T_{vj}=25^\circ C$	-	2.16	-	V
			$T_{vj}=125^\circ C$	-	-	-	
			$T_{vj}=150^\circ C$	-	-	-	
$I_{RM}$	Peak reverse recovery current	$V_R=600V$ $I_F=15A$ $V_{GE}=-15V$	$T_{vj}=25^\circ C$	-	38.60	-	A
			$T_{vj}=125^\circ C$	-	53.17	-	
			$T_{vj}=150^\circ C$	-	-	-	
$t_{rr}$	Reverse recovery time		$T_{vj}=25^\circ C$	-	45.00	-	ns
			$T_{vj}=125^\circ C$	-	99.85	-	
			$T_{vj}=150^\circ C$	-	-	-	
$Q_r$	Recovered charge	$T_{vj}=25^\circ C$	-	0.88	-	$\mu C$	
		$T_{vj}=125^\circ C$	-	2.22	-		
		$T_{vj}=150^\circ C$	-	-	-		

E <sub>rec</sub>	Reverse recovery energy		T <sub>vj</sub> =25°C	-	0.11	-	mJ
			T <sub>vj</sub> =125°C	-	0.47	-	
			T <sub>vj</sub> =150°C	-	-	-	
R <sub>thJC</sub>	Thermal resistance, junction to case	per diode	-	1.75	1.9		K/W
R <sub>thCH</sub>	Thermal resistance, case to heatsink	per diode, λ <sub>grease</sub> =1 W/(m • K)	-	1.30	-		K/W
T <sub>vjop</sub>	Temperature under switching conditions		-40		150		°C

**Diode, Rectifier**

Maximum Rated Values							
Symbol	Item	Conditions		Rating			Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage	T <sub>vj</sub> =25°C		1600			V
I <sub>FRMSM</sub>	Maximum RMS forward current per chip	T <sub>C</sub> =80°C, T <sub>vj</sub> =175°C		30			A
I <sub>RMSM</sub>	Maximum RMS current at rectifier output	T <sub>C</sub> = 80°C		30			A
I <sub>FSM</sub>	Surge forward current	tp = 10 ms, T <sub>vj</sub> =150°C		245			A
I <sup>2</sup> t	I <sup>2</sup> t-value	V <sub>R</sub> =0V, t <sub>p</sub> =10ms, T <sub>vj</sub> =150°C		300			A <sup>2</sup> s

**Characteristic Values**

Symbol	Item	Conditions	Values			Unit	
			Min.	Typ.	Max.		
V <sub>F</sub>	Continuous forward voltage	I <sub>F</sub> =15A V <sub>GE</sub> =0V	T <sub>vj</sub> =25°C	-	1.13	-	V
			T <sub>vj</sub> =125°C	-	-	-	
			T <sub>vj</sub> =150°C	-	-	-	
I <sub>R</sub>	Reverse current	V <sub>R</sub> =1600V	T <sub>vj</sub> =25°C	-	-	10	uA
			T <sub>vj</sub> =125°C	-	-	-	
			T <sub>vj</sub> =150°C	-	-	-	
T <sub>vjop</sub>	Temperature under switching conditions		-40		150	°C	

**IGBT, Brake-Chopper**

Maximum Rated Values							
Symbol	Item	Conditions		Values			Unit
V <sub>CES</sub>	Collector-emitter voltage	T <sub>vj</sub> =25°C		1200			V
V <sub>GES</sub>	Gate-emitter voltage	-		±20			V
I <sub>C</sub>	Collector current,DC	T <sub>C</sub> =100°C, T <sub>vj</sub> =175°C		15			A
I <sub>CRM</sub>	Repetitive peak collector current	t <sub>p</sub> =1ms		30			A
P <sub>tot</sub>	Total power dissipation	T <sub>C</sub> =25°C, T <sub>vj</sub> =175°C		130			W

**Characteristic Values**

Symbol	Item	Conditions	Values			Unit	
			Min.	Typ.	Max.		
IGBT							
I <sub>CES</sub>	Collector-emitter cut-off current	V <sub>CE</sub> =1200V, V <sub>GE</sub> =0V, T <sub>vj</sub> =25°C		-	-	1	mA
I <sub>GES</sub>	Gate leakage current	V <sub>CE</sub> =0V, V <sub>GE</sub> =20V, T <sub>vj</sub> =25°C		-	-	500	nA
V <sub>GE(th)</sub>	Gate-emitter threshold voltage	I <sub>C</sub> =0.5mA, V <sub>CE</sub> =V <sub>GE</sub> , T <sub>vj</sub> =25°C		5.2	5.7	6.5	V
V <sub>CESat</sub>	Collector-emitter saturation voltage	I <sub>C</sub> =15A V <sub>GE</sub> =15V	T <sub>vj</sub> =25°C	-	2.0	-	
			T <sub>vj</sub> =125°C	-	-	-	

			$T_{vj}=150^{\circ}\text{C}$	-	-	-	
$C_{ies}$	Input capacitance	$V_{CE}=25\text{V}, V_{GE}=0\text{V}$ $f=1\text{MHz}, T_{vj}=25^{\circ}\text{C}$		-	1.19	-	nF
$C_{oes}$	Output capacitance			-	0.08	-	
$C_{res}$	Reverse transfer capacitance			-	0.04	-	
$Q_G$	Gate charge	$V_{CC}=600\text{V}, I_C=15\text{A}$ $V_{GE}=-15\dots+15\text{V}, T_{vj}=25^{\circ}\text{C}$		-	94	-	nC
$R_g$	Internal gate resistance	$T_{vj}=25^{\circ}\text{C}$		-	-	-	$\Omega$
$t_{d(on)}$	Turn-on delay time	$V_{CC}=600\text{V}$ $I_C=15\text{A}$ $V_{GE}=\pm 15\text{V}$ $R_{G(on)}=10\Omega$ $R_{G(off)}=10\Omega$	$T_{vj}=25^{\circ}\text{C}$	-	8.73	-	ns
			$T_{vj}=125^{\circ}\text{C}$	-	7.85	-	
			$T_{vj}=150^{\circ}\text{C}$	-	-	-	
$t_r$	Rise time		$T_{vj}=25^{\circ}\text{C}$	-	45.4	-	
			$T_{vj}=125^{\circ}\text{C}$	-	8.14	-	
			$T_{vj}=150^{\circ}\text{C}$	-	-	-	
$t_{d(off)}$	Turn-off delay time		$T_{vj}=25^{\circ}\text{C}$	-	112.2	-	
			$T_{vj}=125^{\circ}\text{C}$	-	125.1	-	
			$T_{vj}=150^{\circ}\text{C}$	-	-	-	
$t_f$	Fall time		$T_{vj}=25^{\circ}\text{C}$	-	325.5	-	
			$T_{vj}=125^{\circ}\text{C}$	-	387.8	-	
			$T_{vj}=150^{\circ}\text{C}$	-	-	-	
$E_{on}$	Turn-on energy (per pulse)	$T_{vj}=25^{\circ}\text{C}$	-	1.62	-	mJ	
		$T_{vj}=125^{\circ}\text{C}$	-	2.04	-		
		$T_{vj}=150^{\circ}\text{C}$	-	-	-		
$E_{off}$	Turn-off energy (per pulse)	$T_{vj}=25^{\circ}\text{C}$	-	0.70	-		
		$T_{vj}=125^{\circ}\text{C}$	-	1.0	-		
		$T_{vj}=150^{\circ}\text{C}$	-	-	-		
SC data	Short-circuit current	$V_{CC}=600\text{V}, V_{GE}\leq 15\text{V}, T_{vj}=125^{\circ}\text{C}$ $V_{CES}\leq 1200\text{V}, t_p\leq 10\mu\text{s}$		-	128	-	A
$R_{thJC}$	Thermal resistance, junction to case	Per IGBT		-	1.05	1.15	K/W
$R_{thCH}$	Thermal resistance, case to heatsink	Per IGBT $\lambda_{grease}=1\text{W}/(\text{m}\cdot\text{K})$		-	1.05	-	K/W
$T_{vjop}$	Temperature under switching conditions			-40		150	$^{\circ}\text{C}$
<b>Diode, Brake-Chopper</b>							
<b>Maximum Rated Values</b>							
Symbol	Item	Conditions			Rating		Unit
$V_{RRM}$	Repetitive peak reverse voltage	$T_{vj}=25^{\circ}\text{C}$			1200		V
$I_F$	Forward current, DC				10		A
$I_{FRM}$	Repetitive peak forward current	$t_p=1\text{ms}$			20		A
$I^2t$	$I^2t$ -value	$V_R=0\text{V}, t_p=10\text{ms}, T_{vj}=125^{\circ}\text{C}$			16		$\text{A}^2\text{s}$
<b>Characteristic Values</b>							
$V_F$	Continuous forward voltage	$I_F=10\text{A}$ $V_{GE}=0\text{V}$	$T_{vj}=25^{\circ}\text{C}$	-	2.20	-	V
			$T_{vj}=125^{\circ}\text{C}$	-	-	-	
			$T_{vj}=150^{\circ}\text{C}$	-	-	-	
$I_{RM}$	Peak reverse recovery current	$V_R=600\text{V}$ $I_F=15\text{A}$	$T_{vj}=25^{\circ}\text{C}$	-	28.8	-	A
			$T_{vj}=125^{\circ}\text{C}$	-	39.5	-	

		V <sub>GE</sub> =-15V	T <sub>vj</sub> =150°C	-	-	-	
t <sub>rr</sub>	Reverse recovery time		T <sub>vj</sub> =25°C	-	44.8	-	ns
			T <sub>vj</sub> =125°C	-	126.7	-	
Q <sub>r</sub>	Recovered charge		T <sub>vj</sub> =25°C	-	0.64	-	μC
			T <sub>vj</sub> =125°C	-	1.79	-	
E <sub>rec</sub>	Reverse recovery energy		T <sub>vj</sub> =25°C	-	0.07	-	mJ
		T <sub>vj</sub> =125°C	-	0.39	-		
R <sub>thJC</sub>	Thermal resistance, junction to case	per diode		-	1.75	1.9	K/W
R <sub>thCH</sub>	Thermal resistance, case to heatsink	per diode, λ <sub>grease</sub> =1 W/(m · K)		-	1.30	-	K/W
T <sub>vjop</sub>	Temperature under switching conditions			-40		150	°C

Note:

IGBT electrical characteristics according to IEC 60747 – 9

Diode electrical characteristics according to IEC 60747 – 2

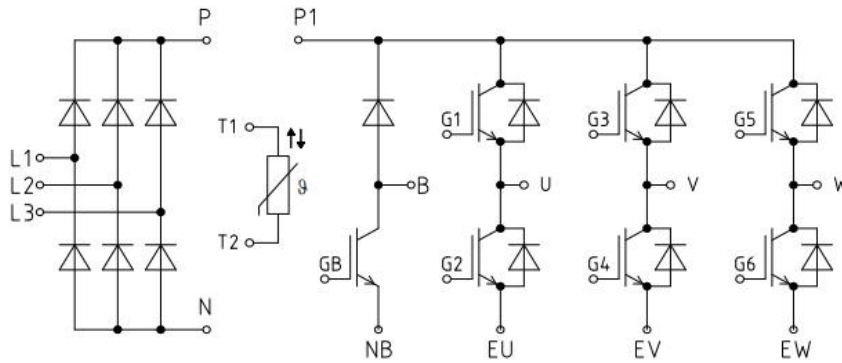
### NTC Thermistor Characteristics

Symbol	Item	Conditions	Values			Unit
			Min.	Typ.	Max.	
R <sub>25</sub>	Rated resistance	T <sub>C</sub> =25°C	-	5	-	kΩ
ΔR/R	Deviation of resistance	T <sub>C</sub> =100°C, R <sub>100</sub> =493Ω	-5	-	5	%
P <sub>25</sub>	Power dissipation	T <sub>C</sub> =25°C	-	-	20	mW
B <sub>25/50</sub>	B-constant	R <sub>2</sub> =R <sub>25</sub> exp[B <sub>25/50</sub> (1/T <sub>2</sub> -1/(298.15K))]	-	3375	-	K
B <sub>25/80</sub>	B-constant	R <sub>2</sub> =R <sub>25</sub> exp[B <sub>25/80</sub> (1/T <sub>2</sub> -1/(298.15K))]	-	3411	-	
B <sub>25/100</sub>	B-constant	R <sub>2</sub> =R <sub>25</sub> exp[B <sub>25/100</sub> (1/T <sub>2</sub> -1/(298.15K))]	-	3433	-	

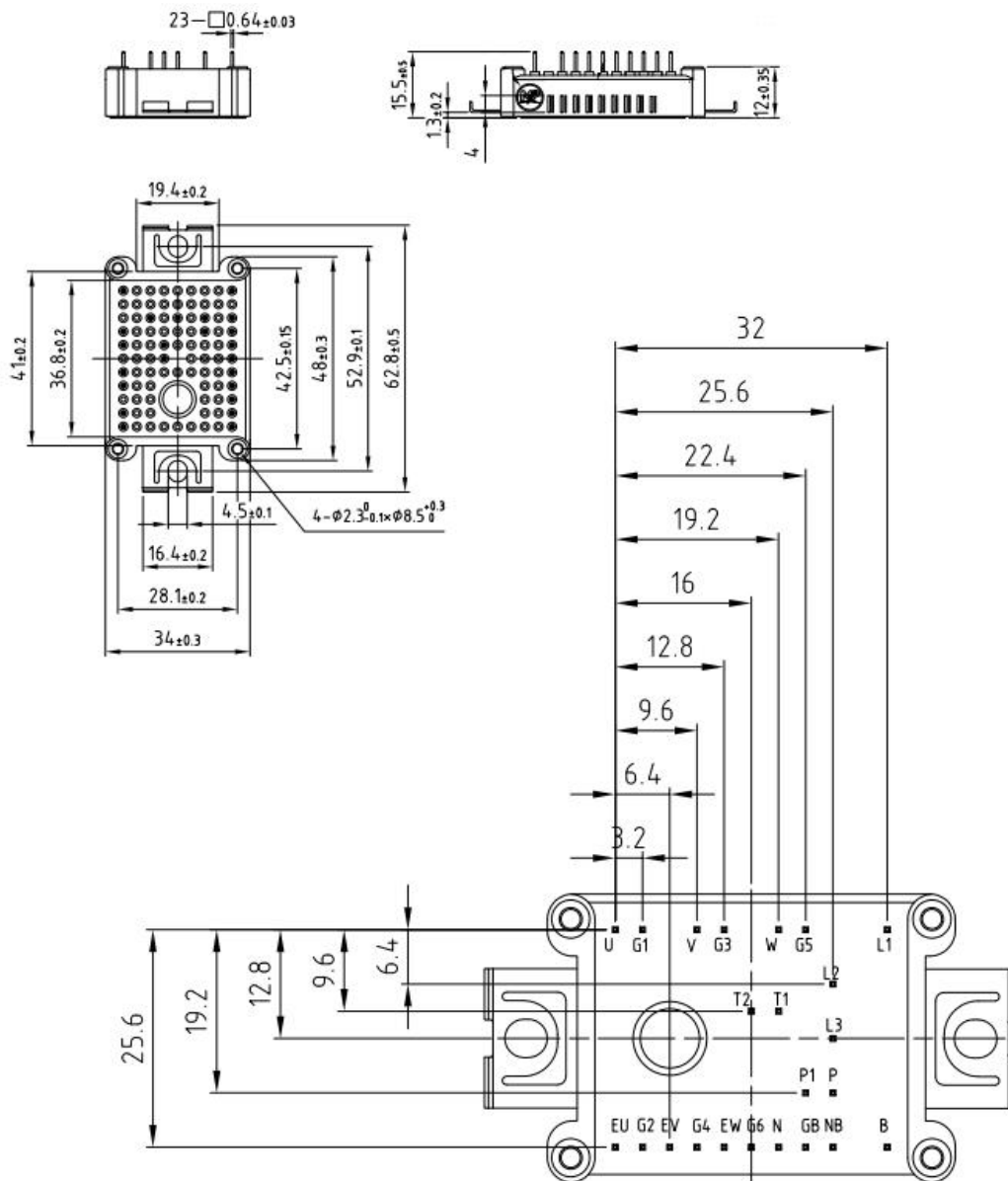
### Module

Symbol	Item	Conditions	Rating			Unit
V <sub>ISOL</sub>	Isolation voltage	Terminals to baseplate, RMS, f=50Hz, t=1min	2500			V
T <sub>vj max</sub>	Maximum junction temperature	-	175			°C
T <sub>vj op</sub>	Operating junction temperature	Continuous operation(underswitching)	-40~150			°C
T <sub>stg</sub>	Storage temperature	-	-40~125			°C
Symbol	Item	Conditions	Values			Unit
			Min.	Typ.	Max.	
F	mounting force per clamp	-	20	-	50	N
ds	Creepage distance	Terminal to terminal	-	6.3	-	mm
		Terminal to base plate	-	11.5	-	
da	Clearance	Terminal to terminal	-	5	-	mm
		Terminal to base plate	-	10	-	
m	Weight	-	-	24	-	g

Circuit Diagram



Package Outlines



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